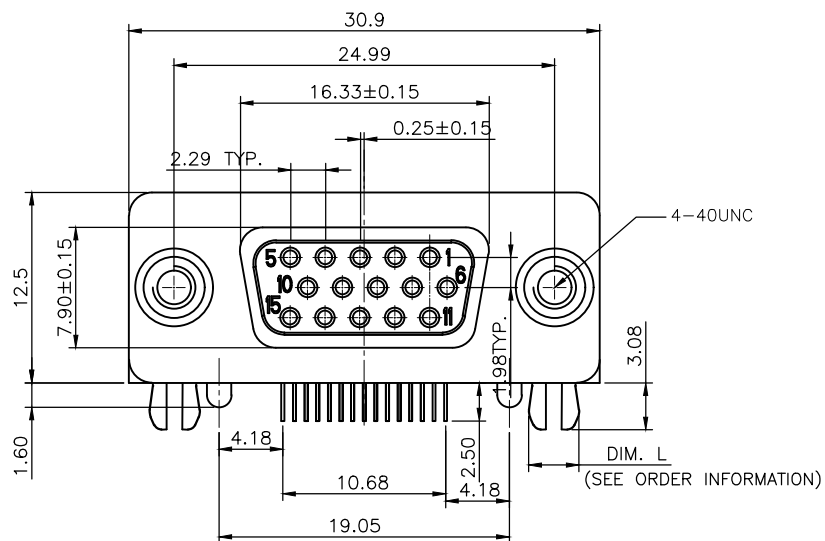
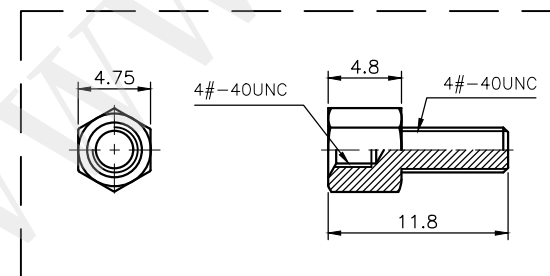
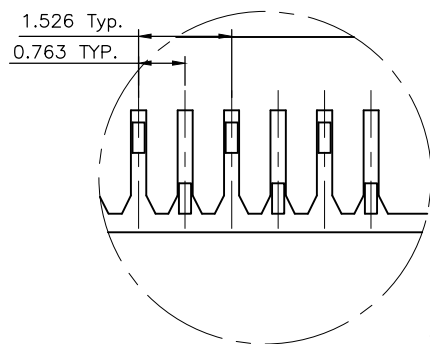
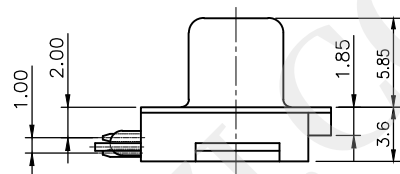
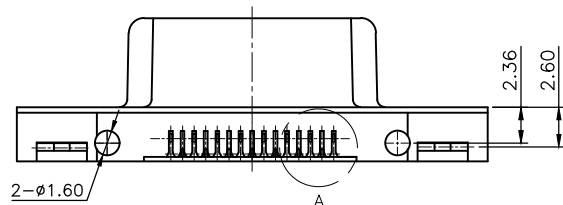


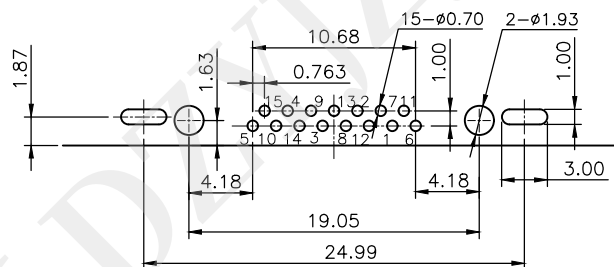
BACK VIEW



SCREW VIEW



DETAIL: A



RECOMMENDED P.C.B LAYOUT(PCB THICKNESS: 1.6mm)
COMPONENT SIDE VIEW(TOLERANCE: ± 0.05)

1. MATERIAL&PLATING:
 - 1.1 INSULATOR: SEE ORDER INFORMATION, 30%G.F, UL94V-0
INSULATOR COLOR: SEE TABLE
 - 1.2 CONTACT: BRASS, GOLD FLASH PLATED IN CONTACT AREA,
80u" MIN TIN PLATED IN SOLDER AREA,
30u" MIN. NICKEL UNDERPLATED OVERALL.
 - 1.3 SHELL: SPCC, NICKEL PLATED OVERALL.
 - 1.4 BOARD LOCK: SPCC, TIN PLATED.
 - 1.5 RIVET: COPPER ALLOY, 30u" MIN. NICKEL UNDERPLATED OVERALL.
 - 1.6 SCREWLOCK: STEEL, NICKEL PLATED OVERALL.
2. SPECIFICATION:
 - 2.1 CURRENT RATING: 1.0A.
 - 2.2 CONTACT RESISTANCE: 30mΩ MAX.
 - 2.3 INSULATION RESISTANCE: 1000MΩ Min.
 - 2.4 DIELECTRIC WITHSTANDING VOLTAGE: 500V PER MINUTE.
3. NOTES:
 - 3.1 ALL COMPONENTS ARE RoHS COMPLIANT.
 - 3.2 RESISTANCE TO SOLDERING HEAT: 265°C FOR 5 SECONDS,
AND ONLY FOR WAVE SOLDERING PROCESS.



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X: ±2" X.X ±0.5"				SLIM 1.0 直鱼叉 前8后7	
		CHECKED BY:	DATE :	PART NO.	HYC175-VGA15B-100
		马跃	2014-02-23	MOLD NO.	
UNIT: mm [inch]		APPROVED BY:	DATE :	DRAW NO:	HYC-2208301548
SCALE:1:1	SIZE: A4	邱敏	2014-02-23	SHEET NO.	1 OF 1